Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

Except below description page
 "Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan

Doc No. TT4-EA-10241

Revision. 2

Panasonic

MOS FET MTM982400BBF

MTM982400BBF

Silicon N-channel MOSFET

For switching

■ Features

- · Low drain-source On-state Resistance RDS(on) typ = 29 m Ω (VGS = 5.0 V)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: CA

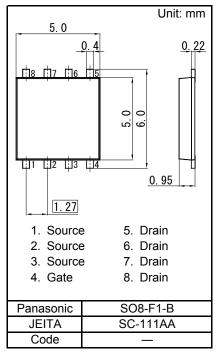
■ Packaging

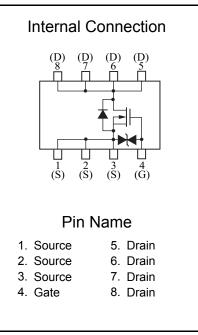
Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings	Ta = 25	°C
Parameter		S

Parameter	Symbol	Rating	Unit
Drain-source Voltage	VDS	40	V
Gate-source Voltage	VGS	±20	V
Drain Current	ID	7	Α
Drain Current (Pulsed)	IDp	28	Α
Total Power dissipation *1	PD	2	W
Channel Temperature	Tch	150	°C
Operating Ambient Temperature	Topr	-40 to +85	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Note: *1 Measuring on ceramic board at 50 mm \times 50 mm \times 1.0 mm.





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Panasonic

MOS FET MTM982400BBF

■ Electrical Characteristics Ta = 25°C ± 3°C

Static Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source Breakdown Voltage	VDSS	ID = 1 mA, VGS = 0 V	40			V
Zero Gate Voltage Drain Current	IDSS	VDS = 40 V, VGS = 0 V			10	μΑ
Gate-source Leakage Current	IGSS	VGS = ±16 V, VDS = 0 V			±10	μΑ
Gate-source threshold Voltage	Vth	ID = 1.0 mA, VDS = 10.0 V	1.0		2.5	V
Drain-source On-state Resistance *1	RDS(on)1	ID = 7 A, VGS = 10 V		16	23	mΩ
	RDS(on)2	ID = 3.5 A, VGS = 5.0 V		29	40	
Forward transfer admittance *1	Yfs	ID = 7 A, VDS = 10 V	4.0			S
Input Capacitance	Ciss			1 750		
Output Capacitance	Coss	VDS = 10 V, VGS = 0 V, f = 1 MHz		150		pF
Reverse Transfer Capacitance	Crss			90		
Turn-on Delay Time *1,*2	td(on)	VDD = 25 V, VGS = 0 to 10 V,		17		no
Rise Time *1,*2	tr	ID = 3.5 A		9		ns
Turn-off Delay Time *1,*2	td(off)	VDD = 25 V, VGS = 10 to 0 V, ID = 3.5 A		94		no
Fall Time *1,*2	tf			33		ns

Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

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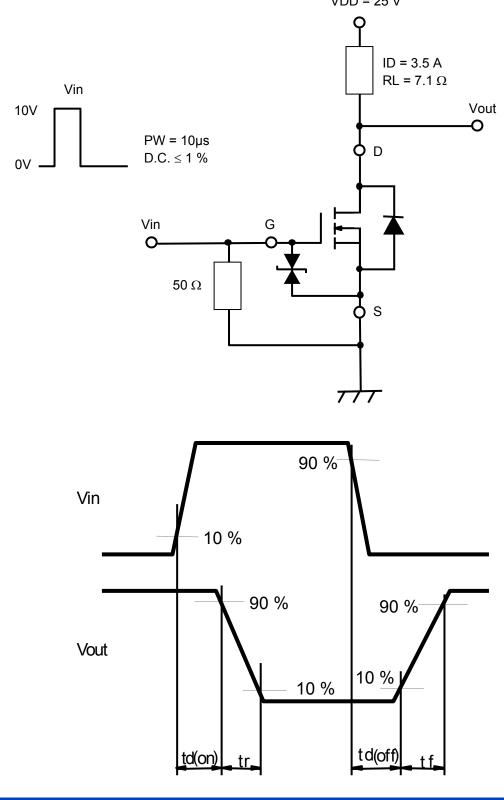
Established: 2007-12-18 : 2013-09-10 Revised

^{2. *1} Pulse test

^{*2} Measurement circuit for Turn-on Delay Time/Rise Time/Turn-off Delay Time/Fall Time

Panasonic

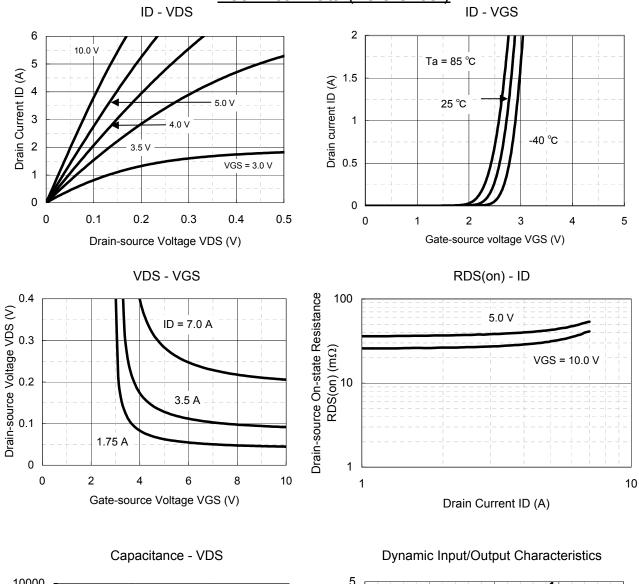
*2 Measurement circuit for Turn-on Delay Time/Rise Time/Turn-off Delay Time/Fall Time VDD = 25 V

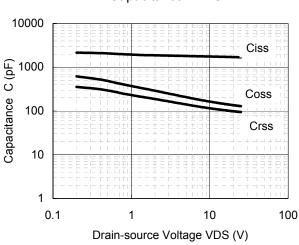


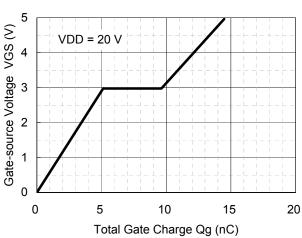
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Technical Data (reference)



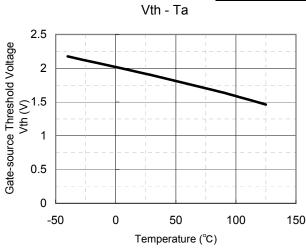


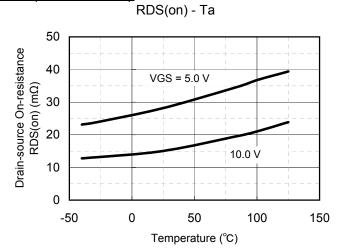


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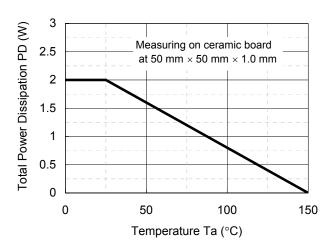
MOS FET MTM982400BBF

Technical Data (reference)

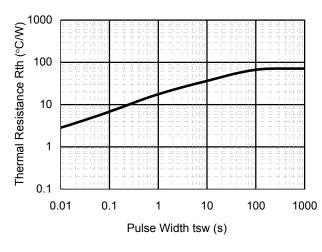


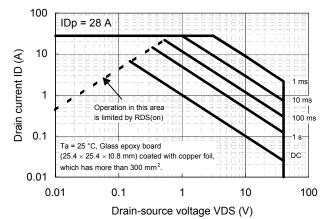


PD - Ta



Rth - tsw Safe Operating Area





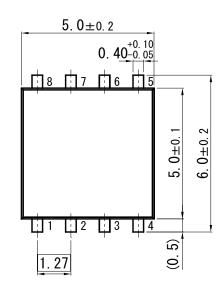
MOS FET

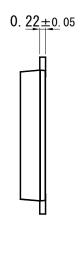
MTM982400BBF

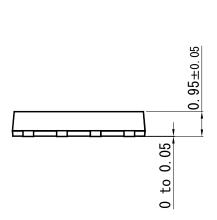
SO8-F1-B

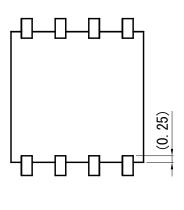
Panasonic

Unit: mm

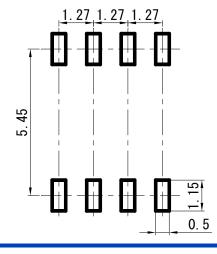








Land Pattern (Reference) (Unit : mm)



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